Top View

Vishay Siliconix

# N-Channel 100 V (D-S) 175 °C MOSFET

# PowerPAK® SO-8DC D D D 8 D D 7 S D 8 S D 6 S D 7 S D 8 S D 8 S D 8 S D 9 S D

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0036			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0042			
Q <sub>g</sub> typ. (nC)	40			
I <sub>D</sub> (A)	148			
Configuration	Single			

**Bottom View** 

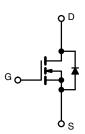
#### **FEATURES**

- TrenchFET® Gen V power MOSFET
- Very low R<sub>DS</sub> Q<sub>g</sub> figure-of-merit (FOM)
- $\bullet$  Tuned for the lowest  $R_{DS}$   $Q_{oss}$  FOM
- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

# ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- · Synchronous rectification
- · Primary side switch
- DC/DC converters
- · OR-ing and hot swap switch
- Power supplies
- · Motor drive control
- · Battery management



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR510EP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	100	
Gate-source voltage		V <sub>GS</sub>	± 20	V
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		148 <sup>a</sup>	
	T <sub>C</sub> = 70 °C	1 . F	124 <sup>a</sup>	
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	33 b, c	
	T <sub>A</sub> = 70 °C	1	27.7 <sup>b, c</sup>	•
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	300	Α
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		136	
	T <sub>A</sub> = 25 °C	l <sub>s</sub>	6.8 <sup>b, c</sup>	
Single pulse avalanche current	. 0.1!!	I <sub>AS</sub>	45	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	101	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		150	
	T <sub>C</sub> = 70 °C	1 , [	105	10/
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	7.5 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C	1	5.25 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	
Soldering recommendations (peak temperature) d, e			260	°C

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient a, b	t ≤ 10 s	$R_{thJA}$	15	20	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	0.8	1	°C/W
Maximum junction-to-case (source)	Steady state	$R_{thJC}$	1.1	1.4	

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 54 °C/W

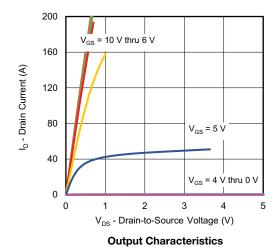
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•		•		
Drain-source breakdown voltage	$V_{DS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	100	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	58	-	m\//0/	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.2	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
		V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15		
Drain-source on-state resistance <sup>a</sup>	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.0030	0.0036	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$	-	0.0034	0.0042		
Forward transconductance <sup>a</sup>	9fs	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$	-	57	-	S	
Dynamic <sup>b</sup>			_		•		
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	4980	-	pF	
Output capacitance	C <sub>oss</sub>		-	1050	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	11	-		
<b>-</b>		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	54	81	nC	
Total gate charge	Qg	$V_{DS} = 50 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$	-	40	60		
Gate-source charge	$Q_{gs}$		-	23.3	-		
Gate-drain charge	Q <sub>gd</sub>		-	3	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$	-	109	-	1	
Gate resistance	$R_{g}$	f = 1 MHz	0.5	1.15	2	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	19	38		
Rise time	tr	$V_{DD} = 50 \text{ V}, R_1 = 2.5 \Omega, I_D \cong 20 \text{ A},$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	29	58		
Fall time	t <sub>f</sub>		-	8	16	1	
Turn-on delay time	t <sub>d(on)</sub>		-	24	48	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 2.5 \Omega, I_D \cong 20 \text{ A},$	-	14	28		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	25	50		
Fall time	t <sub>f</sub>		-	10	20		
<b>Drain-Source Body Diode Characterist</b>	cs				<u> </u>	ı	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	136		
Pulse diode forward current	I <sub>SM</sub>		-	-	300	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.76	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>			56	102	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	65	130	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}C$		26	-	ns	
Reverse recovery rise time	t <sub>b</sub>		_	25	<u> </u>		

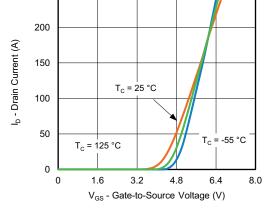
#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



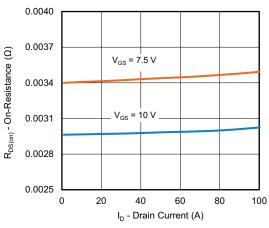


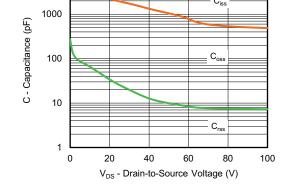


250

10 000

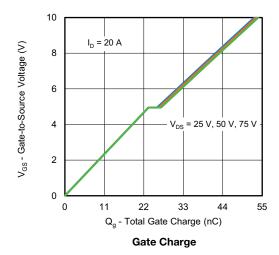
**Transfer Characteristics** 

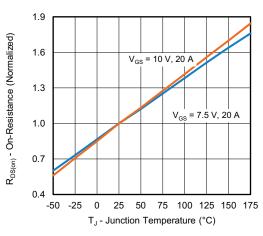




Capacitance

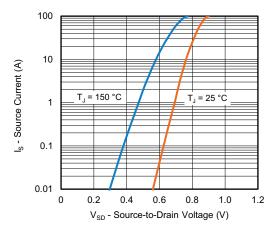
On-Resistance vs. Drain Current and Gate Voltage



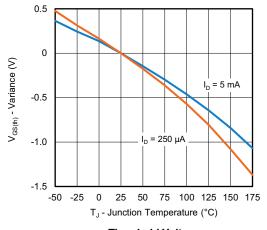


On-Resistance vs. Junction Temperature

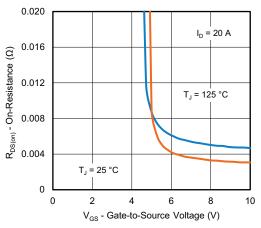




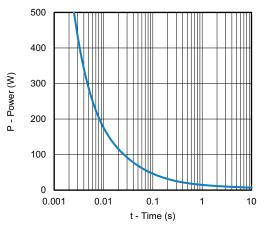
Source-Drain Diode Forward Voltage



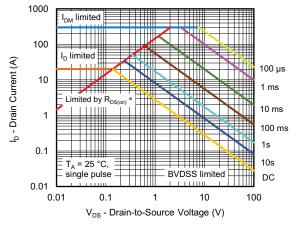
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

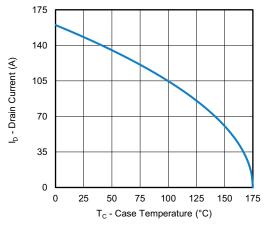


Single Pulse Power, Junction-to-Ambient

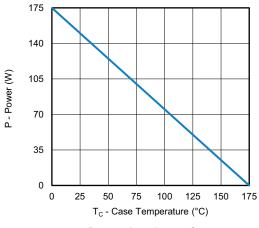


Safe Operating Area, Junction-to-Ambient

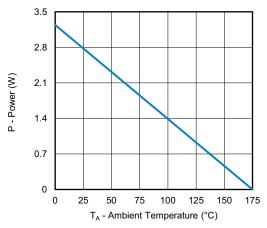








Power, Junction-to-Case

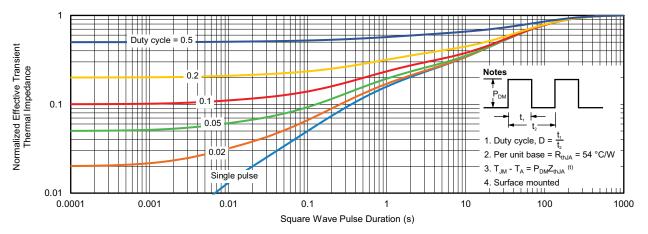


Power, Junction-to-Ambient

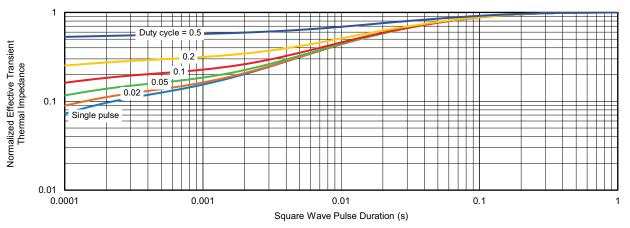
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?63150">www.vishay.com/ppg?63150</a>.



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